

## N-Channel Enhancement Mode MOSFET

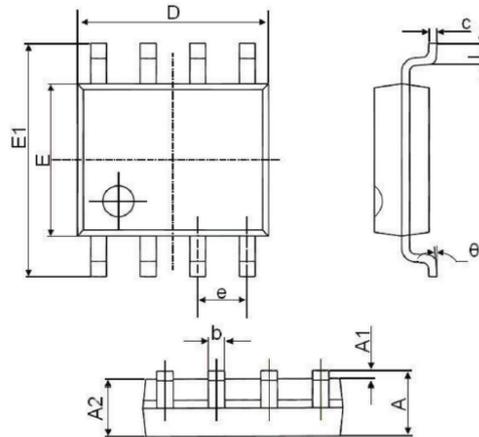
Primary characteristics			
Symbol	Parameter	Value	Unit
$I_D$	Continuous drain current	12	A
$V_{DS}$	Drain source voltage	30	V
$R_{DS(on)}$	Static drain-source on-resistance	9	m $\Omega$ max

### Features

- **SOP-8** case for easy automatic insertion
- Pb-free and **RoHS** compliant
- Advanced trench process technology
- High Density Cell Design For Ultra Low On-Resistance

### Applications

- Power management functions
- Portable Equipment and Battery Powered

Case dimensions, pin configuration											
											
<b>SOP-8</b>											
Sym.	A	A1	A2	b	c	D	E	E1	e	l	$\theta$
mm	1.35 1.75	0.10 0.25	1.35 1.55	0.33 0.51	0.17 0.25	4.70 5.10	3.80 4.00	5.80 6.20	1.27 (BSC)	0.40 1.27	0° 8°

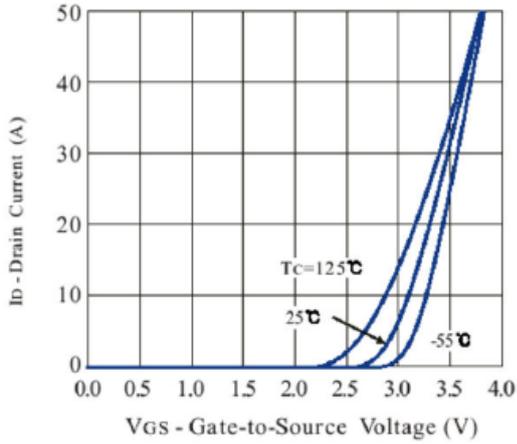
### Maximum ratings ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Value	Unit
Drain-source voltage	$V_{DS}$	30	V
Gate-source voltage	$V_{GS}$	$\pm 20$	V
Continuous drain current	$I_D$	12	A
Pulsed drain current ( $T_C=25^\circ\text{C}$ )	$I_{DM}$	48	A
Power Dissipation	$P_D$	2.5	W
Maximum junction temperature	$T_J$	150	$^\circ\text{C}$
Storage temperature range	$T_{STG}$	-50 ~ 150	$^\circ\text{C}$
Thermal resistance junction-ambient (1 inch <sup>2</sup> pad of 2-oz copper, max.)	$R_{\theta JA}$	50	$^\circ\text{C/W}$

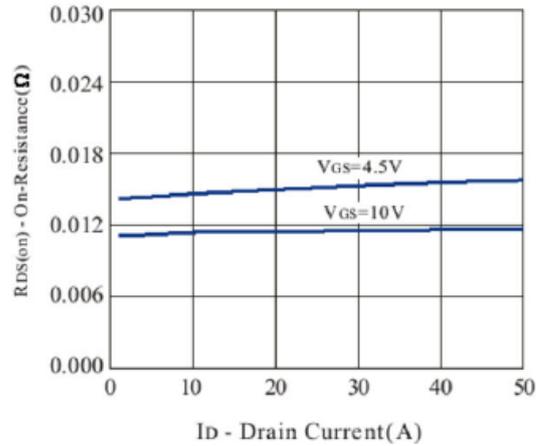
Electrical characteristics (T <sub>J</sub> = 25°C)						
Characteristic	Test condition	Symbol	Value			Unit
			Min.	Typ.	Max.	
Drain-source breakdown voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	V <sub>(BR)DSS</sub>	30	-	-	V
Zero gate voltage drain current	V <sub>DS</sub> =24V, V <sub>GS</sub> =0V	I <sub>DSS</sub>	-	-	1.0	μA
Gate body leakage current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	I <sub>GSS</sub>	-	-	±100	nA
Gate threshold voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	V <sub>GS(TH)</sub>	1.0	-	3.0	V
Drain-source on-state resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =12A	R <sub>DS(ON)</sub>	-	7	9	mΩ
	V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A		-	9.5	12	
Forward transconductance	V <sub>DS</sub> =15V, I <sub>D</sub> =12A	g <sub>FS</sub>	-	60	-	S
Dynamic electrical characteristics (T <sub>J</sub> = 25°C)						
Characteristic	Test condition	Symbol	Value			Unit
			Min.	Typ.	Max.	
Input capacitance	V <sub>DS</sub> =15V V <sub>GS</sub> =0V f=1.0MHz	C <sub>ISS</sub>	-	1066	-	pF
Output capacitance		C <sub>OSS</sub>	-	164	-	
Reverse transfer capacitance		C <sub>RSS</sub>	-	119	-	
Turn ON delay time	V <sub>DS</sub> =15V V <sub>GS</sub> =10V I <sub>D</sub> =1A R <sub>GEN</sub> =6Ω	t <sub>d(ON)</sub>	-	12.5	-	ns
Turn ON rise time		t <sub>r</sub>	-	12.3	-	
Turn OFF delay time		t <sub>d(OFF)</sub>	-	44	-	
Turn OFF fall time		t <sub>f</sub>	-	10.1	-	
Total gate-charge	V <sub>DS</sub> =15V V <sub>GS</sub> =10V I <sub>D</sub> =12A	Q <sub>G</sub>	-	18.8	-	nC
Gate to source charge		Q <sub>GS</sub>	-	1.9	-	
Gate to drain (Miller) charge		Q <sub>GD</sub>	-	4.5	-	
Source-drain diode characteristics						
Characteristic	Test condition	Symbol	Value			Unit
			Min.	Typ.	Max.	
Diode forward voltage	V <sub>GS</sub> =0V, I <sub>S</sub> =2A	V <sub>DS</sub>	-	-	1.5	V

Typical characteristics

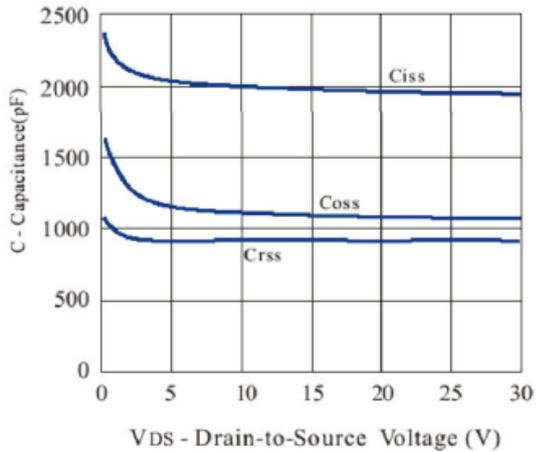
Transfer characteristics



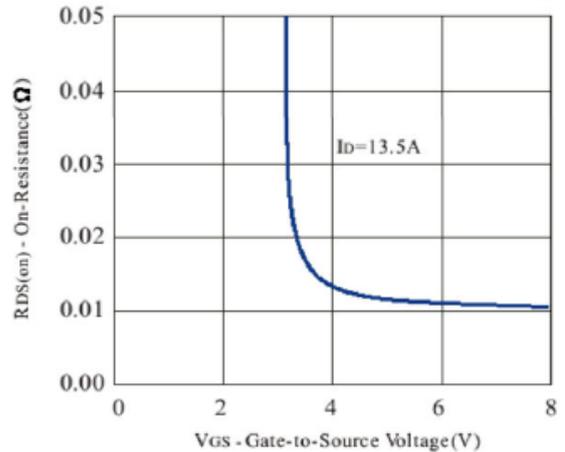
On-Resistance vs. Drain Current



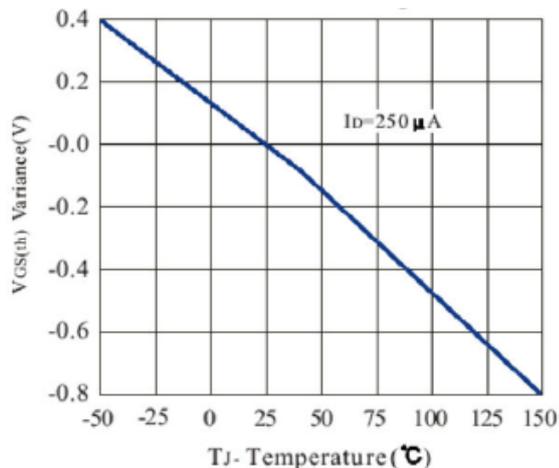
Capacitance



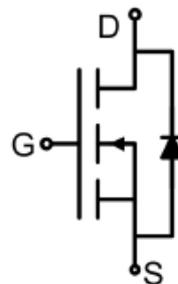
On-Resistance vs. Gate-to-Source Voltage



Threshold voltage



Circuit diagram



Ordering information				
Part Number	Marking	Package	Shipping Quantity	Dimensions
AKS4406S	4406	SOP-8	4000 pcs / tape & reel	---

## Disclaimer

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